

Title (en)

METHOD FOR PRODUCING A COMPONENT AND COMPONENT

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES BAUTEILS SOWIE BAUTEIL

Title (fr)

PROCEDE DE REALISATION D'UN COMPOSANT ET COMPOSANT CORRESPONDANT

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Abstract (en)

[origin: WO2008099009A1] The invention relates to a method for producing a component, comprising an inlay piece (1), enclosed by a plastic layer, wherein, in a first step, at least a part of the inlay piece (1) is coated with a plastic moulding mass (2) of low viscosity and in a second step, the inlay piece with the coating is injection moulded with a synthetic resin component (3), or the inlay piece (1) is coated with a synthetic resin component (3), wherein regions of the inlay piece (1) are not coated and the non-coated regions are cast with a plastic moulding mass (2) of low viscosity. The invention further relates to a component, an inlay piece (1) and a plastic coating made up of at least two plastic components, wherein the first plastic component, which at least partly directly coats the inlay piece (1), is a plastic moulding mass (2) of low viscosity and the second plastic component is a plastic resin component (3).

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